

Docket No.: 49677-091

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application of

Shinichi YAMAGATA, et al.

Serial No.: 09/925,427

Filed: August 10, 2001

: Customer Number: 20277

: Confirmation Number: 5385

: Group Art Unit: 1742

: Examiner: Jenkins, Daniel J.

For: SUBSTRATE MATERIAL FOR MOUNTING A SEMICONDUCTOR DEVICE,  
SUBSTRATE FOR MOUNTING A SEMICONDUCTOR DEVICE, SEMICONDUCTOR  
DEVICE, AND METHOD OF PRODUCING THE SAME

**INFORMATION DISCLOSURE STATEMENT**

Mail Stop IDS  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This Information Disclosure Statement is being filed more than three months after the U.S. filing date and after the mailing date of a Final Rejection or Notice of Allowance, but before payment of the Issue Fee.

**REQUEST TO CONSIDER REFERENCES AFTER CLOSE OF PROSECUTION AND  
BEFORE PAYMENT OF ISSUE FEE**

The undersigned hereby requests consideration and entry of this Information Disclosure Statement and accompanying references under 37 CFR 1.97(d).

Please charge the processing fee under 1.17(p) of \$180.00 to Deposit Account 500417.

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CERTIFICATION PARAGRAPH

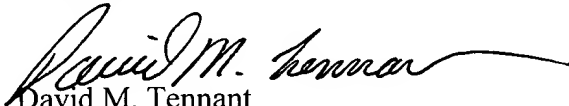
The undersigned certifies that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 CFR 1.97(e)(2).

The relevance of USP 3,262,762, to Bechtold et al. was learned of on August 10, 2004 in a phone call from the Examiner, which may be applicable to allowed claim 41.

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

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